

Maderas. Ciencia y Tecnología

ISSN: 0717-3644 ananias@ubiobio.cl Universidad del Bío Bío Chile

Okino, E. Y. A.; Teixeira, D. E.; Del Menezzi, C. H. S.

Post-thermal treatment of oriented strandboard (OSB) made from cypress (cupressus glauca lam.)

Maderas. Ciencia y Tecnología, vol. 9, núm. 3, septiembre, 2007, pp. 199-210

Universidad del Bío Bío

Concepción, Chile

Available in: http://www.redalyc.org/articulo.oa?id=48590301



Complete issue

More information about this article

Journal's homepage in redalyc.org



ISSN 0717-3644 ISSN online 0718-221X

# POST-THERMAL TREATMENT OF ORIENTED STRANDBOARD (OSB) MADE FROM CYPRESS (CUPRESSUS GLAUCA LAM.)

E. Y. A. Okino<sup>1</sup>, D. E. Teixeira<sup>2</sup>, C. H. S. Del Mene

## **ABSTRACT**

The objective of this research was to determine the physical and mechanical properties of orien strandboard (OSB) using strands of *Cupressus glauca* Lam., before and after a thermal treatment well as to evaluate the susceptibility of the boards to fungi attack. Boards with nominal density of 0 g/cm³ were produced with 5% and 8% of urea-formaldehyde (UF) resin. Physical and mechan properties were evaluated according to ASTM D 1037 (1991) standard and compared with CSA O43 and ANSI A.208.1 standards. All mechanical properties were higher than those values required by 8 standards, except the modulus of elasticity in parallel axis. The thermal treatment slightly reduced modulus of elasticity and stress at proportional limit, both in perpendicular axis, however improsignificantly dimensional stability. Dimensional stability of the treated OSB was improved at the loresin level but did not reach the maximum value required by the Canadian standard. Biological as showed that heat-treated cypress OSB exposed to *P. sanguineus* reduced mass loss from 39% to 50 while for *G. trabeum* the reduction was from 40% to 49%. Post thermal treatment of manufactures OSB (190°C, 720 s) can be the recommended method to reduce the hygroscopicity without great effort mechanical properties and to protect panels against these fungi.

**Keywords**: oriented strandboard, material properties, thermal treatment, biodeterioration.

## **INTRODUCTION**

Plywood and oriented strandboard (OSB) panels are very similar in the conception of reducing dimensional stability and anisotropy of the wood, but raw material, manufacturing process mechanical properties are very different. The disadvantage of OSB compared to plywood is the high dimensional instability. To improve this property it is necessary to reduce the water adsorption of wood and release the stress imposed during the hot-pressing process. Some studies have evaluate method which can do this in an one-way step: the thermal treatment applied after the consolidation the panel.

One of the first studies to evaluate this kind of treatment was conducted by Roffael and Ra (1973). They evaluated di-isocyanate bonded particleboards exposed to 200°C for 15 to 60 minimand the results showed a decrease in thickness swelling (TS) and water absorption (WA). The mode of rupture (MOR) was reduced up to 20%. Shen (1974) exposed urea-formaldehyde bonded partfrom 260 to 343°C during two to four seconds pressed from 200 to 600 psi. No significant chang MOR and shear strength was observed. Hsu *et al.* (1989) heat-treated phenol-formaldehyde bon waferboard at 240°C during 2.67, 4.16 and 10.50 minutes and verified an enhancement in TS ar slightly deleterious effect on the MOR. They also concluded that stiffness is more affected by ther treatment than strength. Suchsland and Xu (1991) also studied yellow-poplar flakeboard under 23

during 15 minutes and concluded that TS value was clearly diminished. It can be observed that the exists no work concerning the utilization of thermal treatment on UF bonded wood panels, probabecause this type of resin can be degraded under these conditions.

On the other hand, it is very well known that thermal treatment has a deleterious effect on mechan properties of wood. According to Bengtsson *et al.* (2002), the heat-treatment decreases the strer and the stiffness of the wood. However, the extent of loss may vary either by the heat-treatment sched or the wood species. Softwoods have shown larger reductions in strength than hardwoods. Usually, bending and tensile strength of heat-treated material is reported to drop between 10% and 30%. Goro and Hale (2002) studied the effect of heat treatment from 200°C to 260°C with increments of 1 during 20 minutes on the mechanical and physical properties of strands. They concluded that it temperature treatments resulted in significant reductions in thickness swelling of wood strands as was in modulus of rupture and modulus of elasticity by 20%.

A very promising method to improve dimensional stability has been studied in Brazil since 200 is a kind of post-thermal treatment where panel is re-pressed and heated, with pressure enough ensure contact between the panel and the press platens. Recently, Del Menezzi and Tomaselli (20 employed this treatment (250°C, 240 s, 420 s, 600 s) in a single layered OSB from *Pinus taeda*, to 0.8 g/cm³ nominal density and 8% of phenol-formaldehyde resin, and observed reduction in equilibrium moisture content (EMC) and permanent thickness swelling (PTS). Del Menezzi (20 used this same method to treat commercial pine OSB bonded with phenol-formaldehyde in sur layer and di-isocyanate in the core layer at 190°C and 220°C during 720 s, 960 s, and 1200 s.

Thickness swelling decreased in 39% and 25%, after 2 and 24 h of water immersion, respective while WA was reduced in average 31% and 17%, respectively. There was a decrease in average 5.9% in mechanical properties, but this was not statistically significant. This relative low impact mechanical properties could be attributed to as a strategy on thermal treatment, such as fast heat conduction and short time of treatment. However, they observed that the total amount of hemicellule was reduced by 20% for treated OSB (220°C, 1200 s), so panels became less hygroscopic. Thus hemicelluloses are degraded, some improvement can be expected on the resistance against funging decrease it is the main wood polymer source of these organisms. In fact, several studies have demonstrated the thermal treatment is effective in enhancing this property. According to Yang et al. (20 southern yellow pine OSB were exposed to 14 brown-rot and 8 white-rot decay fungi. In general brown-rot fungi degraded OSB to a greater extent than did white-rot fungi. The rate of degradad was the same as that of solid wood, but higher weight loss was obtained with OSB.

In this context, the cypress species was chosen to manufacture OSB with the purpose of evaluating potential as raw material for the panel industry. The Laboratório de Produtos Florestais - LP federal government laboratory has sponsored researches using cypress to generate basic data (Okin al., 2006), technological properties of cement-bonded particleboard (Okino et al., 2005) and acetyla particleboard (Okino et al., 2004). It was also planned other studies about OSB manufacturing as a stechnical feasibility evaluation of the thermal post-treatment for panels made from other woods have been proved to be suitable for reconstituted composites. The objective of this research was manufacture cypress OSB and expose them to post press-heat treatment to determine the physimechanical properties and susceptibility of the boards to different fungi of the treated and untreacontrol specimens.

# MATERIAL AND METHODS

## **Wood Material**

Logs of cypress *Cupressus glauca* Lam., approximately 17-year-old, were collected in Bras Brazil, and processed into blocks of 20x100x190 mm. This material was converted into strands rotative disc flaker. The strands were sieved in a mechanical screen device and only those past through a 24 mm aperture and retained on a 8 mm sieve were used. These strands were dried in electrical oven at  $105^{\circ}$ C to reach constant humidity content around 4%. The final dimension of strands was approximately 0.7x20x70 mm ( $t \times w \times l$ ).

#### **OSB** Manufacturing

The 13-mm thick mats were hand-formed and pressed on manually controlled hydraulic ste heated press platens at 175°C and 4.0 MPa of pressure for 8 minutes. The boards were manufactured with two resin levels (5% and 8%) based on the oven-dry weight of the strands. Ammonium chlo at 5% was used as a catalyst and no wax was added. The UF resin (CASCAMITE PB 2346, A Química Ltd) was chosen to evaluate the degree of enhancement of the dimensional stability of boards when thermal treatment was applied. It presented 66% of solid contents and the viscosity adjusted to 267mPa.s at 25°C. The non-volatile content was determined according to ASTM D 1467 (1972) and the viscosity was measured with a Brookfield Viscometer Model VRF-100. The result was sprayed using a rotary blender DRAIS FSP 80. For each resin level, six three-layer boards wis surface/core layer ratio of 50/50 were manufactured. Each panel measured 450x450x13 mm and hominal target density of 0.70 g/cm³. After the production the boards were room conditioned at (65± and (20±1)°C to reach constant weight.

#### Thermal Treatment

After the conditioning each board was trimmed (430x430 mm) to eliminate low density edge cut so as to obtain two halves (210x430 mm). One half was thermally treated at 190°C during minutes using a single-opening hot press while the other one remained untreated. A pressure applied just to provide the contact between press plates and the boards' surfaces.

#### Physical and Mechanical Properties

Physical and mechanical properties of the treated and untreated boards were evaluated accordin ASTM D1037 (1996) standard. Two specimens were cut following parallel (//) and perpendicular axis for static bending testing to determine modulus of rupture (MOR), modulus of elasticity (Mand stress at proportional limit (SPL), while three specimens were cut for internal bond (IB) and for screw withdrawal (SW) and Janka hardness (JH). These tests were conducted using an INSTR 1127 Universal Testing Machine. To evaluate physical properties, four samples were cut for was absorption (WA), thickness swelling (TS), apparent specific mass and moisture content (MC) testing the same and the same apparent specific mass and moisture content (MC) testing the same apparent specific mass and moisture content (MC) testing the same apparent specific mass and moisture content (MC) testing the same apparent specific mass and moisture content (MC) testing the same apparent specific mass and moisture content (MC) testing the same apparent specific mass and moisture content (MC) testing the same apparent specific mass and moisture content (MC) testing the same apparent specific mass and moisture content (MC) testing the same apparent specific mass and moisture content (MC) testing the same apparent specific mass and moisture content (MC) testing the same apparent specific mass and moisture content (MC) testing the same apparent specific mass and moisture content specific mass and moisture spec

## Biological Assay

The laboratory decay test followed ASTM D 2017-05 (2005) standard, with twelve specim assigned per treatment. Two brown-rot fungi (*Gloeophyllum trabeum* (Persoon ex Fries) Murrill, *Lent lepideus* Fries) and two white-rot fungi (*Pycnoporus sanguineus* (Persoon ex Fr.) Murrill e *Ganode applanatum* (Persoon ex Wallroth) Patouillard) were tested and maintained in the Laboratóric Produtos Florestais (LPF). Two woody support samples (*Pinus* sp. and *Cecropia* sp.) were used dimensions 3.0x29x35 mm to provide the initial growth of the fungi. The flasks were autoclave 121°C during 60 minutes and the incubator room condition was (26.7±1.1)°C and relative humi

(70+4)%. Twelve replicates per treatment measuring 25x25 mm by the thickness of the boards v

## Experimental design

The test results were submitted to analysis of variance (ANOVA) using the SPSS 13.0 for Windo (Statistical Program for Social Science), and the comparison among treatments' means was test using the Tukey HSD test at 5% significance level.

## **RESULTS AND DISCUSSION**

#### Physical and Mechanical Properties

The values of mechanical properties are shown in Figure 1. The MOR values in the parallel direct were 1.3 to 1.8 fold higher than the minimum value required by CSA O437.0 standard, class 6 which is 29 MPa. The MOR values in perpendicular direction were also 2.3 to 2.8 folds higher than minimum value required by the same class, which is 12.4 MPa. The ratios of MOR between para and perpendicular directions ranged from 1.5 to 1.9, showing the degree of strands alignment. Ethough, there was no significant difference among the four treatments, the thermal treatment causin decrease of 15% in the parallel MOR. This trend was also observed in the perpendicular MOE at 8% resin level. The panel density of the four treatments was near target density and no signified difference among means was identified.

Comparing MOR values between untreated cypress OSB with 8% UF resin and aspen OSB v 3.5% PF resin (Ayrilmis et al, 2005), the first showed mean values 45% higher. Compared with con 8% UF resin cypress OSB, the commercial pine sheathing and flooring OSB (Wang et al, 2004) MOR values, in perpendicular and parallel direction, reduced by 49% and 38%, respectively.

All MOE values in parallel direction were lower than the minimum required by CSA O437.0 stand class O-2, which is 5,500 MPa. The MOE values in the perpendicular direction were in average 1.5 1.7 fold higher than the standard requirement, which is 1,500 MPa. The MOE ratios between para and perpendicular directions ranged from 1.3 to 1.5.

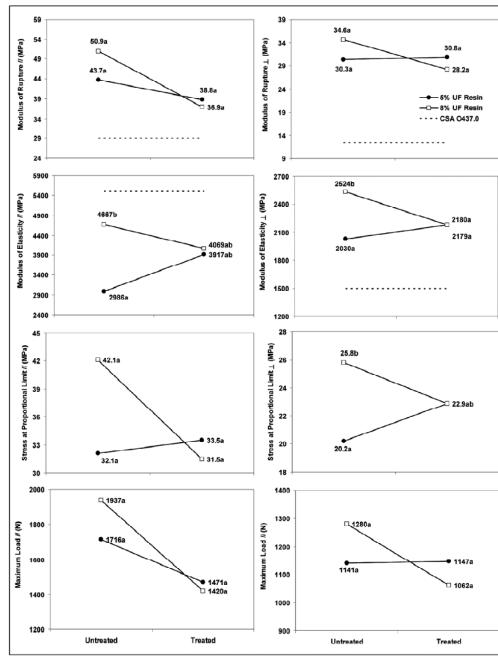


Figure 1: Static bending properties of control and thermally treated OSB made from cypress. (Values followed by a different letter are statistically different at  $\alpha = 0.05$ , according to Tukey H test).

The resin level was significant only for those panels that were not submitted to the thermal treatment. The treatment caused a decrease in the elasticity only for the panels with 8% resin in the perpendic direction. Regarding mechanical properties, the thermal treatment did not have any effect, excepthe MOE in the perpendicular direction of alignment within panels bonded with 8% resin.

Mean values of SPL in the parallel direction showed no difference among treatments, while in perpendicular direction they showed two homogeneous groups. The treatment had no effect on property, but the resin level had, for SLP in the perpendicular direction and only for the untreapanels. As predicted, mean values of maximum load in the parallel direction were higher than in perpendicular direction, without any difference among treatments.

Results presented in Figure 1 show that heat-treated OSB at 5% UF generally experienced increase mechanical performance, except to MOR and maximum load, in parallel direction, whereas with UF this trend is not shown. It might be that the secondary heat-treatment further cured the 5% UF reand/or negatively affected the 8% UF cure.

The values of IB, SW and JH are presented in Figure 2. The IB values were higher than minin required by CSA O437.0, class O-2, which is 0.345 MPa. In general, these values were 1.5 to higher than the requirement, evidencing the good bonding quality of the strands. The thermal treath did not have any effect on the IB and no difference was observed among the four treatments. Compa the results obtained, the values observed were approximately 38% higher than those obtained by Ayril et al (2005) for aspen OSB with 3.5% PF resin. SW and JH values were 1.4 to 2.0 folds higher those required by ANSI A.208.1 and CSA O437.0 standard, class O-2. No evidence was observed means differences among the treatments according to the Tukey test on SW and JH.

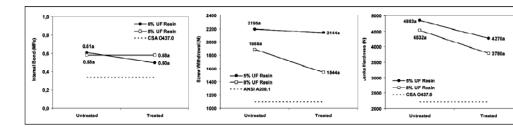


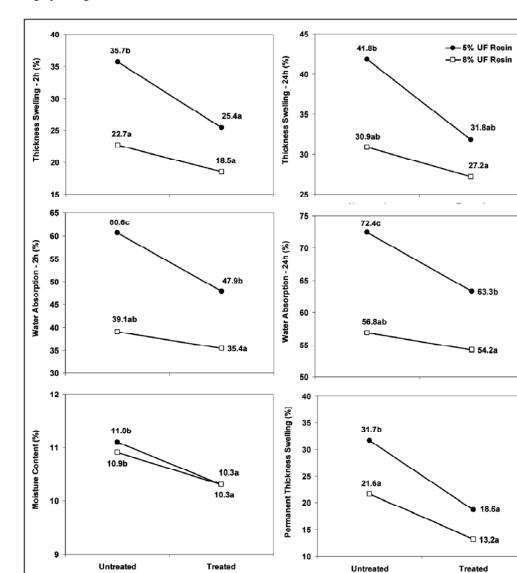
Figure 2: Internal bond, screw withdrawal and Janka hardness of control and thermally treated C made from cypress. (Values followed by a different letter are statistically different at  $\alpha = 0.05$  according to Tukey HSD test).

Based on these results there are a great potential to use cypress as an alternative reforesta species since special attention is given in the genetic improvement and also management.

The results of the physical properties are presented in Figure 3. The thickness swelling after hours of water soaking exceeded the maximum value required by CSA O437.0, class O-2. The ther treatment improved dimensional stability to a higher extent at the lower resin level. Regarding the resin level, the treatment was not so efficient as to improve dimensional stability. Contrary to tre shown in Figure 1, the physical property results shown in Figure 3 seems to show that 8% UF cles out-performed 5% UF. This behavior could be related to the known lack of UF-water-resistance.

(190°C, 720 s) was studied, the best conditions found in the study by Del Menezzi (2004), both thick swelling and water absorption decreased after the thermal treatment, showing a direct relation between them, rather still the treatment did not attend the maximum requirement to thickness swel after 24 h.

Apparent specific mass ranged from 0.691 to 0.749 g/cm³ and according to Tukey test it show only one homogeneous group. Comparing apparent specific mass between control and treated 0 with 8% UF resin, the values were 0.749 and 0.702 g/cm³, respectively. Secondary thermal treated did not caused a densification of the panels, so physical and mechanical properties should not highly changed.



Thermal treatment resulted in improved dimensional stability of the manufactured OSB, on find the permanent thickness swelling (PTS) or "springback", showing a reduction in average 41% to 3 in thickness when compared to control boards, due to the sum of two components, the swelling of wood itself and the release of compression stresses from pressing operation. In the other cases, percentage of mass loss, on oven-dried basis, was approximately 9% to both resin contents, with significant differences. The moisture content was between 10% and 11%, and the thermal treaspecimens showed lower water uptake.

In general, reduction in strength and stiffness is the result of elevated temperatures for an extentime. These changes are generally attributed to the thermal degradation of the wood substance. Impand bending are the most degraded wood properties, whilst bending stiffness and major weight loss least affected (Yildiz *et al*, 2002b), and OSB behaves in a similar way.

## **Biological Properties**

The results of the laboratory decay test ranked the panels into the classes "resistant" and "hig resistant," according to ASTM D 2017-05(2005). The thermal treatment caused a significant decrease in the mass loss for the fungi *P. sanguineus* and *G. trabeum*, at 5% and 8% resin level, while remain almost unchanged for *G. applanatum* and *L. lepideus*.

Tukey test showed that both thermally treated OSB, with 5% and 8% UF resin, exposed *P.sanguineus* showed one homogeneous group, which might suggest that a lower resin content treatment by applied giving the same results. Nevertheless, taking in account the fact that mechanical propresults went way up on post-pressing, secondary thermal-treatment, it might be that UF was not tot cured and thus excess urea and formaldehyde were present for non-thermal treated material at 5% resin. It was identified that OSB exposed to *G. applanatum* showed one homogeneous group, this both increasing resin content and thermal treatment were not effective to improve the biolog resistance. The same result was observed when OSB was exposed to *L. lepideus*. On the other has OSB exposed to *G. trabeum* and *P. sanguineus* showed two and three homogeneous groups, respective thus evidencing that thermal treatment had the same effect as increasing in 3% the resin content panels, so an economic study should be carried out to decide which treatment is advisable. Del Men (2004) demonstrated the economic feasibility of this kind of thermal treatment (190°C, 1200 s; 220 s) and calculated the rise in the production cost as much as 5%. OSB with 5% UF-untreated parassayed with *G. trabeum* showed only one homogeneous group different from the other treatment

Figure 1.

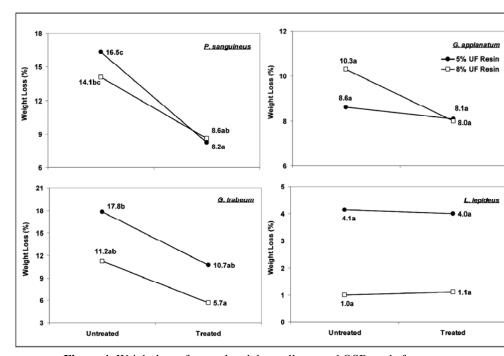


Figure 4: Weight loss of control and thermally treated OSB made from cypress.

Yang et al (2000) found 37.3% and 49.0% mass losses on G. applanatum and G. trabeum, respective which are 3.6 and 2.8 times higher when compared to the present study; they also obtained a neglig mass loss of just 1.8% on P. sanguineus. Chung et al cited by Yang et al (2000) stated that structure design of OSB lead to large voids, which provide abundant paths for fungal hyphae to penetrate degrade the wood. Therefore, faster and more extensive degradation of OSB was expected. They verified that in general the brown-rot fungi caused more degradation and greater mass loss than white-rot fungi, but this statement has not been entirely evidenced in this study. Moreover, the la standard deviations listed by them were in accordance with some aforementioned results of a biolog assay, showing the great sensibility and variability of fungi tests. Ayrilmis et al (2005) conductor decay laboratory test with brown-rot fungus Fomitopsis palustris (Berk. et Curt) Gilbn. & Ryn and white-rot fungus Trametes versicolor (L. ex. Fr.) Quel., using 3.5 % PF resin in control aspen O and found 18.77% and 16.23% mass loss, respectively. These mass losses are in accordance with highest mass loss described to 5% UF resin control OSB. Goroyias and Hale (2002b) treated 3% bonded Scots pine unaligned strandboards (210°C, 320 s) with a 1% wax content and tested aga Coniophora puteana, Postia placenta, Trametes versicolor and Pleurotus ostreatus. The results for white rot fungi showed little, if any effect of the heat treatment on decay. Heated strandboard (250 720 s) only achieved 24% and 20% reduction in weight loss on C. puteana and P. placenta, respective In this study thermal treated 5% UF strandboards (190°C, 12 min) achieved a reduction of 40% 50% mass loss on G. trabeum and P. sanguineus, respectively, while 8% UF strandboards show reduction of 49% and 39%, which seems to be a good approach to enhance the panels durability. As this whole result might be possibly explained by the enhanced UF resin curing that was observe al, 2000), and since white-rot fungi for their metabolism also are dependent on conversion hemicellulose, its reduction is believed to be the main cause of the increased resistance against the fungi, mainly on *P. sanguineus*.

Maritime pine and poplar heat-treated (200 to 250°C, 6 h) wood showed the presence of polynuc aromatics hydrocarbons derivatives of phenantrene and acenaphytylene due to degradation of w constituents. It is most likely that the presence of all such compounds contributes - perhaps to a relative substantial extent - to the reported resistance of heat-treated timber to fungal and other biolog attack (Kamdem *et al*, 2000). Similar findings correlated to tropolones compounds' natural prodefound in cypress wood may also difficult the fungi attack.

## CONCLUSION

All mechanical properties of UF resin bonded cypress OSB were higher than the Canac requirements, except MOE in the parallel direction. Mechanical properties of modulus of rupt parallel stress at proportional limit, internal bond, screw withdrawal, maximum load, and Janka hardrewere not affected by the thermal treatment. Otherwise, the proposed thermal treatment improved properties related to dimensional stability and it was effective to enhance the durability against the from four fungi evaluated. Dimensional stability was improved in the lower resin level panels. Panels presented good resistance to the tested fungi and were graded as "resistant" or "highly resistated higher improvement in susceptibility of the OSB was observed in the decay test of the white fungus *P. sanguineus* in treated panels. Further studies should be focused on determining the crit level of pressing time and resin level.

It is recommended the conduction of a complete research increasing the processing parameters other types of adhesives.

## **ACKOWLEDGEMENTS**

Laboratório de Produtos Florestais-LPF/IBAMA thanks the person of Dr. Mário de Andrade fr Alba Química Ltda., who supplied the resins, and Mr. Francisco Ozanan C. C. Alencar, Chefe Departmento de Parques e Jardins da NOVACAP/DF, and Marco Aurélio Silva, who kindly provi the cypress wood. We are in debt to Ms. Theodora Fischli who revised the article. The team also tha the technicians who collaborated in the execution of this project: Mr. João E. Anacleto, Sérgio Martin Luiz D. Santana, Francisco L. de Araújo, Ricardo P. de O. Santos and Dionísio A. do Monte.

## REFERENCES

**American National Standard. 1993**. Mat-formed wood particleboard: Specification ANSI A20 1993. Gaithersburg: National Particleboard Association. 9p.

American Society for Testing and Materials. 2005. Accelerated laboratory test natural de resistance of woods. ASTM D2017-05. Philadelphia: ASTM, v.04.09, 2005. (Annual Book of AS Standards).

American Society for Testing and Materials. 1967. Standard test method for nonvolatile con of urea-formaldehyde resin solutions: ASTM D 1490 - 67. Annual Book of ASTM Standards, 04.09, American Society for Testing and Materials, Philadelphia, PA.

**Ayrilmis, N.; Kartal, SN.; Laufenberg, TL.; Winandy, JE.; White, RH. 2005** Physical mechanical properties and fire, decay, and termite resistance of treated oriented strandboard. *For Prod. J.*, 55(5):74-81

**Bengtsson, C.; Jermer, J.; Brem, F. 2002.** Bending strength of heat-treated spruce and pine tim In: Annual Meeting International Research Group on Wood Preservation, Proceedings, 33, Cardin Wales, UK, 12 -17 May.

Canadian Standards Association. 1993. OSB and waferboard. Ontario: CSA 0437-93, 1993.

**Del Menezzi, CHS. 2004.** Estabilidade dimensional por meio do tratamento térmico e seus efe sobre as propriedades de painéis de partículas orientadas (OSB). Ph. D. Dissertation on Forest Prod Technology and Utilization. UFPR, Curitiba, p 226 (in Portuguese).

**Del Menezzi, CHS. Tomaselli, I. 2006.** Contact thermal post-treatment of oriented strandboar improve dimensional stability: A preliminary study. *Holz als Roh- Werkst.* v. 64, n. 2, p. 212-217.

**Goroyias, GJ.; Hale, MD. 2002a**. Heat treatment of wood strands for OSB production: Effect the mechanical properties, water absorption and dimensional stability. In: Annual Meeting Internation Research Group on Wood Preservation, Proceedings, 33, Cardiff, p 18

**Goroyias, GJ.; Hale, MD. 2002b.** The effect of high temperature and long pressing time on dimensional stability and decay resistance of OSB. In: Annual Meeting International Research Gron Wood Preservation, Proceedings, 33, Cardiff, p 20

**Hsu, WE.; Schwald, W.; Shields, JA. 1989.** Chemical and physical changes required for production dimensionally stable wood-based composites. Part 2: Heat post-treatment. *Wood Sci. Tech.* 23(3):281-288

**Kallander, B.; Bengesson, C.; Dahlberg, J. 2001.** Influence of drying in temperatures betw 70°C and 120°C on selected wood properties of Norway spruce. In: International IUFRO Wood Dry Conference, Proceedings, 7, Tsukuba, p 6

**Kamdem, DP.; Pizzi, A.; Triboulot, MC. 2000.** Heat-treated timber: potentially toxic byprod presence and extent of wood cell wall degradation. *Holz Roh- Werkst.* 58:253-257

**Kim, G-H.; Yun, K-E.; Kim, J-J. 1998**. Effect of heat treatment on the decay resistance bending properties of radiata pine sapwood. *Material und Organismen* 32(2):101-108

**Kubojima, Y.; Okano, T.; Ohta, M. 2000.** Bending strength and toughness of heat-treated wo *J. Wood Sci.* 46(1):8-15

Maloney, TM. 1977. Modern Particleboard and Dry-Process Fiber Board Manufacturi

- Matsumoto, T.; Matsumoto, H.; Fujimoto, N.; Fujimoto, Y.; Murase, Y. 2001. Influence thermal treatments on the mechanical properties of wood. In: International IUFRO Wood Confere Proceedings, 7, Tsukuba: p 4
- Militz, H. 2002. Thermal treatment of wood: European Processes and their background. In: An Meeting International Research Group on Wood Preservation, Proceedings, 33, Cardiff, p 10
- Okino, EYA.; Camargos, JAA.; Santana, MAE.; Marques, MHB.; Martins, VA.; Sousa de.; Teixeira, DE. 2006. Descrição dos caracteres tecnológicos da madeira de *Cupressus glauca* L *Scientia Forestalis*. 72 39-48.
- Okino, EYA.; Souza, MR de.; Santana, MAE.; Alves, MV da S.; Sousa, ME de.; Teixeira, 2005. Physico-mechanical properties and decay resistance of *Cupressus* spp. cement-bon particleboards *Cement & Concrete Composites* 27 333-338.
- Okino, EYA.; Souza, MR de.; Santana, MAE.; Alves, MV da S.; Sousa, ME de.; Teixeira, 2004. Evaluation of the physical and biological properties of particleboard and flakeboard made f Cupressus spp. International Biodeterioration & Biodegradation 53 1-5.
- **Roffael, E.; Rauch, W. 1973.** Einfluß von Temperatur und thermischer Nachbehandlung auf ein physikalische Eigenschaften von diisocyanat-gebundenen Spanplatten. *Holz als Roh- Wer* 31(10):402-405
- **Shen, KC. 1974.** Improving the surface quality of particleboard by high-temperature press *Forest Prod. J.* 24(10):36-39
  - Suchsland, O.; Xu, H. 1968. Model analysis of flakeboard variables. Forest Prod. J. 8(8):24
- **Syrjänen, T.; Kangas, E. 2000.** Heat-treated timber in Finland. In: Annual Meeting Internation Research Group on Wood Preservation, Proceedings, 31, Kona, p 9
- **Tjeerdsma, BF.; Stevens, M.; Militiz, H. 2000.** Durability aspects of (hydro)thermal treated wo In: International Research Group on Wood Preservation, Kona, 31, p 10
- Wang, S.; Gu, H.; Neimsuwan, T. 2004 Understanding properties of commercial OSB produ In: Pacific Rim Bio-Based Composites Symposium, Proceedings, 7, Nanjing, 7, p 3
- Yang, VW.; Nelson, WJ.; Illman, BL.; Ross, RJ. 2000. Nondestructive Evaluation of Biodegra Oriented Strandboard: Laboratory Results. In: Annual Conference PATH consortium for wood-fra housing, Proceedings, 2, Madison, 227-230
- Yildiz, S.; Çolakoglu, G.; Yildiz, UC.; Gezer, ED.; Temiz, A. 2002a. Effects of heat treatmen modulus of elasticity of beech wood. In: Annual Meeting International Research Group on W Preservation, Proceedings, 33, Cardiff, p 6
- **Yildiz, S. 2002b.** Effects of heat treatment on water repellence and anti-swelling efficiency beech wood. In: Annual Meeting International Research Group on Wood Preservation, Proceeding 33, Cardiff, p 6